

Webinar

Increasing efficiency in buildings
with mmWave radar

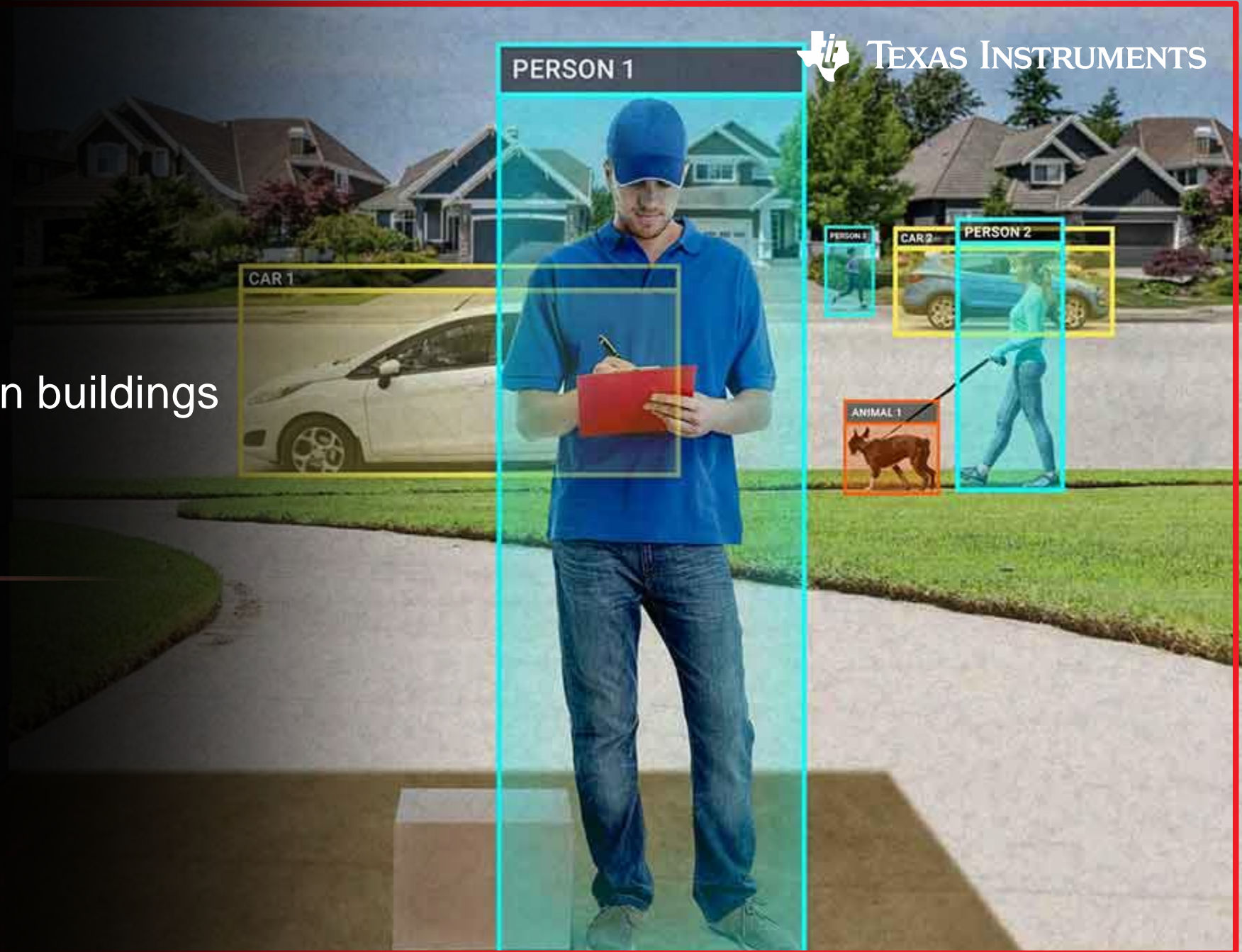
Colin Hice

Systems engineer

Kottyn Quintanilla

Product marketing engineer

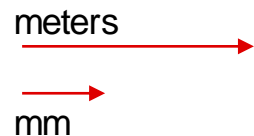
 TEXAS INSTRUMENTS



What is mmWave technology?

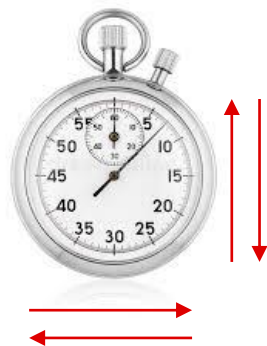
Repeatable, Dependable, Accurate Sensing...

Range



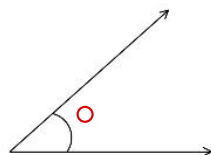
Measuring distance or change in distance of object from the sensor

Velocity



Displacement or motion signature for classification and monitoring

Angle



Azimuth & Elevation for localization

...in challenging conditions












Camera-less



Contact-less



Radar | building automation

-  Presence Detection
-  Major / Minor Motion Detection
-  Localization
-  Counting / Tracking
-  Static Object Detection
-  Velocity and Direction Detection
-  Stance / Fall Detection
-  Heart & Breath Rate Detection
-  Human vs non-Human Classification

Indoor Applications



Keypads/Video Doorbells



Commercial Doors



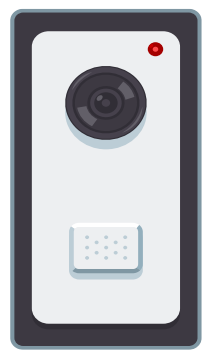
Smart Thermostats



Industrial Doors

Building automation using TI mmWave

Sensing that guarantees timely door opening, enhanced pedestrian safety, and reduced building energy losses



Surveillance Applications

- Robust in conditions such as rain and snow
- Reduce false detections to reduce power consumption



Commercial Doors

- Efficiently detect objects walking towards the door and ignore objects whose trajectory is not towards the door





Thermostats/HVAC

- Detect, track and count the number of people in an area to improve space utilization and for more efficient use of HVAC

TI mmWave Features	Sensing Benefits
3D Presence + Static Object Detection +Tracking	High accuracy 3D detection of multiple people/objects (moving) in the area of interest. Detect static objects/people in the door pathway
Object's Velocity Information	Adapt to the speed of approaching people/objects to make intelligent decision as to when to open the door and when to close the door
Immune to Environmental Conditions	Increase reliability over existing PIR /microwave sensors, low false triggers in bright daylight ,dark environments, and other environmental factors such as rain, snow, fog, etc.
Increase Battery Life with False Trigger Mitigation	Confirm motion detection events from other sensors with higher accuracy, significantly reducing power consumption by decreasing erroneous system wakeups in battery powered applications.


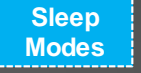

IWR6843 | IWRL6432 performance / power

IWR6843 / AOP




4 RX	Cortex R4F 200MHz	SPI
3 TX	1.75 MB RAM	UART
10MHz I/F	FFT – 200MHz	QSPI
57-64GHz Synth	C6x DSP 600MHz	I2C
		Security

- Tracking: up to 10 people w/ 85% accuracy
- Max range: up to 100 meters
- Classification: advanced human / non-human
- Heart rate / Breathing rate accuracy: ± 5 bpm / ± 2 bpm
- Power consumption: up to 2W

Performance

		
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IWRL6432

3 RX	Cortex M4F 160MHz	SPI
2 TX	1 MB RAM	UART
5MHz I/F	FFT- 80MHz	QSPI
57-64GHz Synth		I2C
	Sleep Modes	

- Tracking: up to 5 people w/ 85% accuracy
- Max range: up to 20 meters
- Classification: human / non-human
- Heart rate / Breathing rate accuracy: ± 10 bpm / ± 4 bpm
- Power consumption: < 2mW

Power

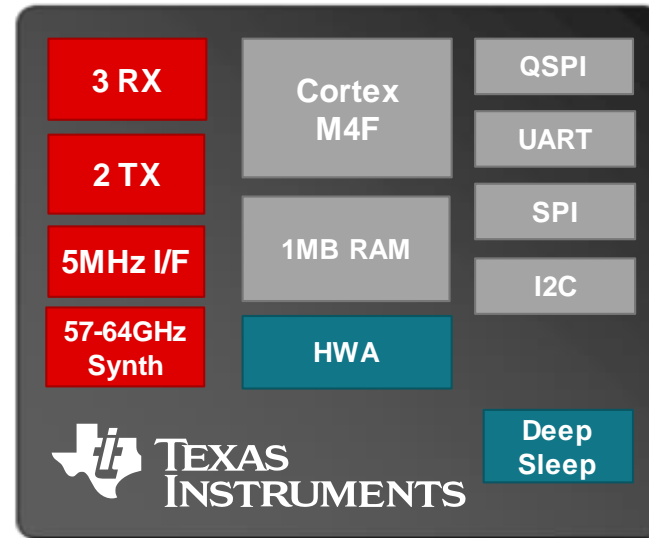
- FCCSP
 - Samples: Now
 - Production: 1Q24



Fully integrated
4Rx, 3Tx
1-patch antennae
on package
(AOP)

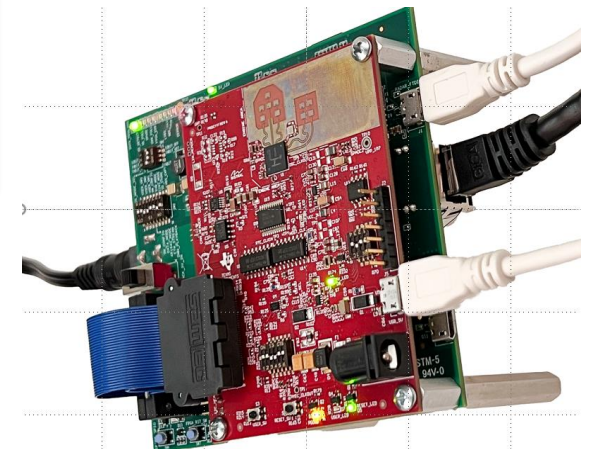
IWRL6432 | product overview

- Designed for **small form factor**, **low BOM cost** and **lower power applications**
- **Integrated transceivers** : 3 Rx and 2 Tx
- **Integrated frequency synthesizer**: 57GHz to 64GHz
- **Processing**:
 - Arm® Cortex®-M4F MCU @ 160 MHz
 - Integrated FFT, CFAR-CA HWAs
- **Memory**: 1.0 MB SRAM
- **Interfaces**: SPI, UART, I2C, QSPI, GPIOs
- **System simplification**
 - Multiple power modes to enable ultra-low power
 - One, two or three power-rail topologies (1.8V, 1.2V, 3.3V)
- **Package**:
 - 6.45 x 6.45 mm FCCSP (0.5mm pitch) -- **Samples Now**



Sample/EVM: Now

Production: Q1 2024



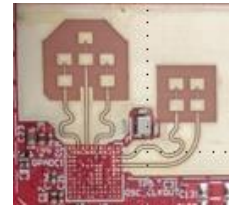
IWRL6432 | Design Options

Reference design



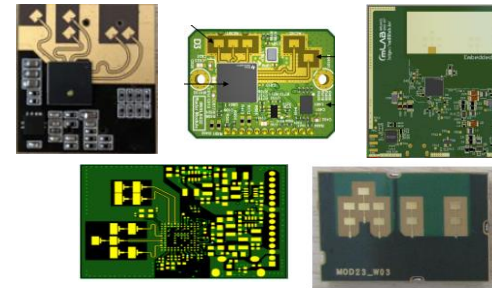
- Full reference design including radar, power management, passives, antenna etc.
- TI provides design files, layout, gerber, pcb stack, simulation and test results
- IWRL6432WCSP reference design (today)
- IWRL6432 FCCSP reference design (today)
- IWRL6432AOP reference design (in design)
- TIDA-010254 reference design (November)

Antenna-only reference design



- Pre-validated antenna design from IWRL6432BOOST EVM (2-patch)
- Use simulated antenna designs from TI catalog
- TI provides
 - Layout
 - Dfx files
 - Simulation results
 - PCB stackup
 - Design reviews
 - Radome reviews
 - Test results (EVM only)

System-on-Module



- Pre-qualified module including power management, passives, PCB, Xtal etc.
- Customizable antenna designs
- Various sizes and radar performance



3rd party network

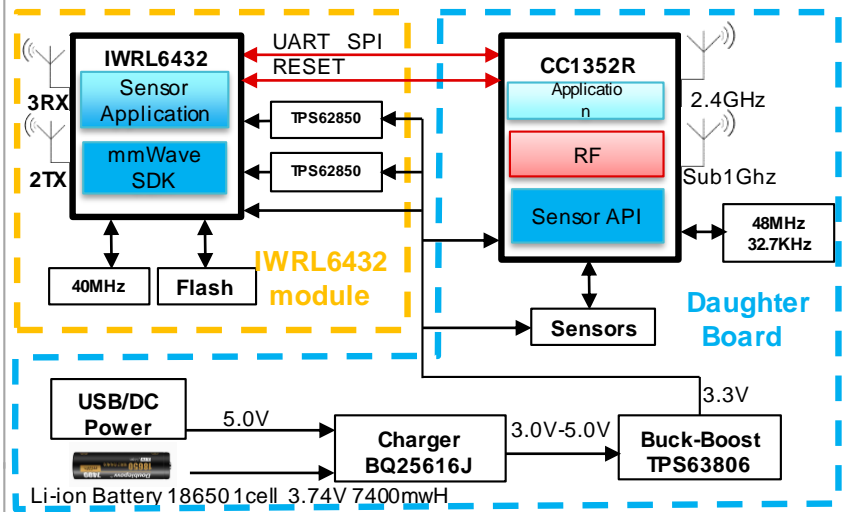
- New [ti.com tool](#) to help customers find radar partners to fill development gaps and accelerate time to market
- Select from multiple categories of capabilities and end applications
- Partners Include:
 - Turnkey designs – complete hardware & software
 - Evaluation – hardware & demo software
 - Services – hardware & software design services

Battery Powered low-cost TI mmWave radar reference design

Design challenge/problem statement

- Battery powered **standalone** demo board has high privacy in home use cases.
- Detection** is independent of **area conditions** like light, dust, smoke, etc.
- Ultra low-power** mmWave sensor that enables longer operation time in battery powered applications.
- Communications with smart home system by **wired or wireless** interfaces.

Block diagram/schematic



Additional resources

	60GHz mmWave	Wireless MCU
GPN	IWRL6432	CC1352R
Description	Low-power, low cost mmWave sensor + HWA + MCU	Arm Cortex M4F, sub-1 GHz and 2.4-GHz wireless Bluetooth5.2, Zigbee
Technical resources	<ul style="list-style-type: none"> Sensor Sequencing Using the CC13x2 and CC26x2 Sensor Controller Low Power mmWave radar enables new functionality in battery powered proximity se 	

What differentiates this subsystem solution

- Precise minor motions, person sitting detection indoor.
- Determine if motion detected in coarse region of interest.
- Location of up to 3 people walk tracking.
- Patient vital signs and position signs detection.
- External processor: Classification of human vs non-human objects.
- External processor: Classification of human stance/behavior.

Sims/measurements

	TI (demo board)	2-patch, ISK antenna on FR408HR	IWRL6432 module Daughter Board
Power source	18650 Li-battery		
Comm Mode	UART, SPI		
Antenna	PCB lay out		
Wireless Protocols	Bluetooth 5.2 LE Zigbee		
Sensors	Temp & Humi HDC3020 Hall effect DRV5032 Light OPT3004 PIR IRA-S210		
		Device Mode	Power (mW, 25deg)
		Deep Sleep	0.583 (1.8V IO)
		Idle	1.226 (3.3V IO)
		Processing	144.6

Early power test

EEs benefitting from this subsystem

- Appliances > Major appliance > Refrigerator & freezer
- Appliances > Service robot > Robotic lawn mower
- Building automation > Building Security System > Video doorbell
- Building automation > Building Security System > Motion detector (PIR, mmWave, etc.)
- Building Automation > Building Security System > Occupancy detection (people tracking & counting)
- Building Automation > Video surveillance > IP network camera

Power consumption optimization

Debug steps	Related part	I @ 3.3V Board A
Remove R179	LED	1888 μ A
Remove IIC pull up R4/R75	IIC	1710 μ A
Remove UART pull up R73/R74	UART	1118 μ A
Remove GPADC2 pull up R67	GPADC2	1078 μ A
Remove BUCK MODE pull up R238/R244/Q3, shut MODE to GND	BUCK MODE	1020 μ A
J10 change to input in SW	BUCK MODE	854 μ A
SW set FLASH in SHUTDOWN mode	Need double check the code change	--
Change R49/R44 to 2M	FLASH pull up	665 μ A
Set RAM retention in OOB demo	RAM	588 μ A

Deep sleep mode
Sleep current

Deep sleep + motion detection demo running with 1 chirp per frame @ 1Hz		350 μ A (average current) ~1.15mW
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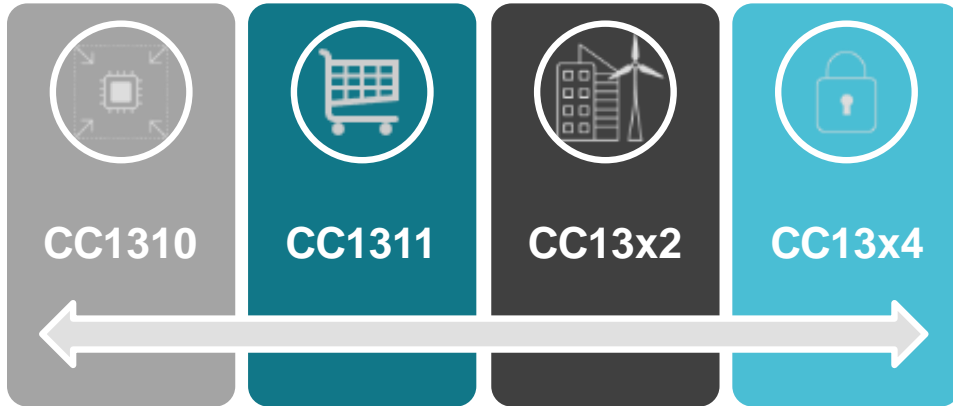
Deep sleep +
motion detection
Average current

CC13xx Wireless MCUs

Robust. Long Range. Low Power.

Scale your application with pin-to-pin, software compatible options and the industry's lowest power technology

Sampling Now



Flash / RAM memory (bytes)

1024k / 256k

704k / 144k

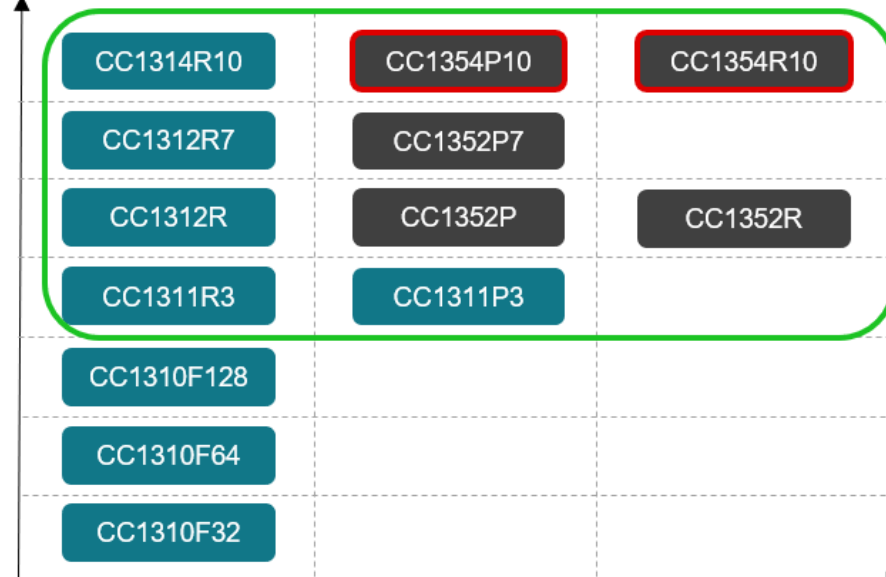
352k / 80k

352k / 32k

128k / 20k

64k / 20k

32k / 16k



Legend:

■ Sub-1 GHz

■ Dual-band

□ Coming soon!

□ Internal FAB

CCxxxxR – 14 dBm

CCxxxxP – 20 dBm

Parameter	0-series	1-series	2-series	4-series
Arm Cortex	M3	M4	M4F	M33
Dual-band	-	-	Optional	Optional
Radio	Gen. 1	Gen. 2	Gen. 2	Gen. 3
High Power PA	-	Optional	Optional	Optional
Security	Mid	Mid	Mid+	High
Sensor Controller	Gen. 1	-	Gen. 2	Gen. 2
SDK	Fam. 1	Fam. 2	Fam. 2	Fam. 2
Standby current	0.7 μ A	0.7 μ A	0.8 μ A	0.9 μ A

48-pin VQFN
30 GPIOs

48-pin VQFN
26 GPIOs

48-pin VQFN
28 GPIOs

Same Pin out

CC1352P and CC1352P7 product overview

48 MHz MCU with up to 704 kB flash, dual-band and 20 dBm PA

Features

Ultra-low Power Consumption

- MCU Current: 60 μ A/MHz
- 0.85 μ A standby with full RAM retention and RTC
- 5.8 mA RX
- 24.9 mA TX at +14 dBm
- 63.0 mA TX at +20 dBm

MCU

- 48 MHz Arm® Cortex®-M4F
- 352/704 KB Flash w/ 8KB cache
- 80/144 KB ULL RAM
- 1.8 – 3.8 V supply range

Security

- AES-128/256, SHA-256/512, ECC

RF Key Features

- Output power:
 - Up to +14 dBm on Sub-1 GHz
 - Up to +5 dBm on 2.4 GHz
 - Up +20 dBm on both bands
- Sensitivity:
 - -110 dBm (50kbps GFSK)
 - -121 dBm (2.5kbps SL-LRM)
- Down to 4 kHz RX BW (narrowband)

Peripherals

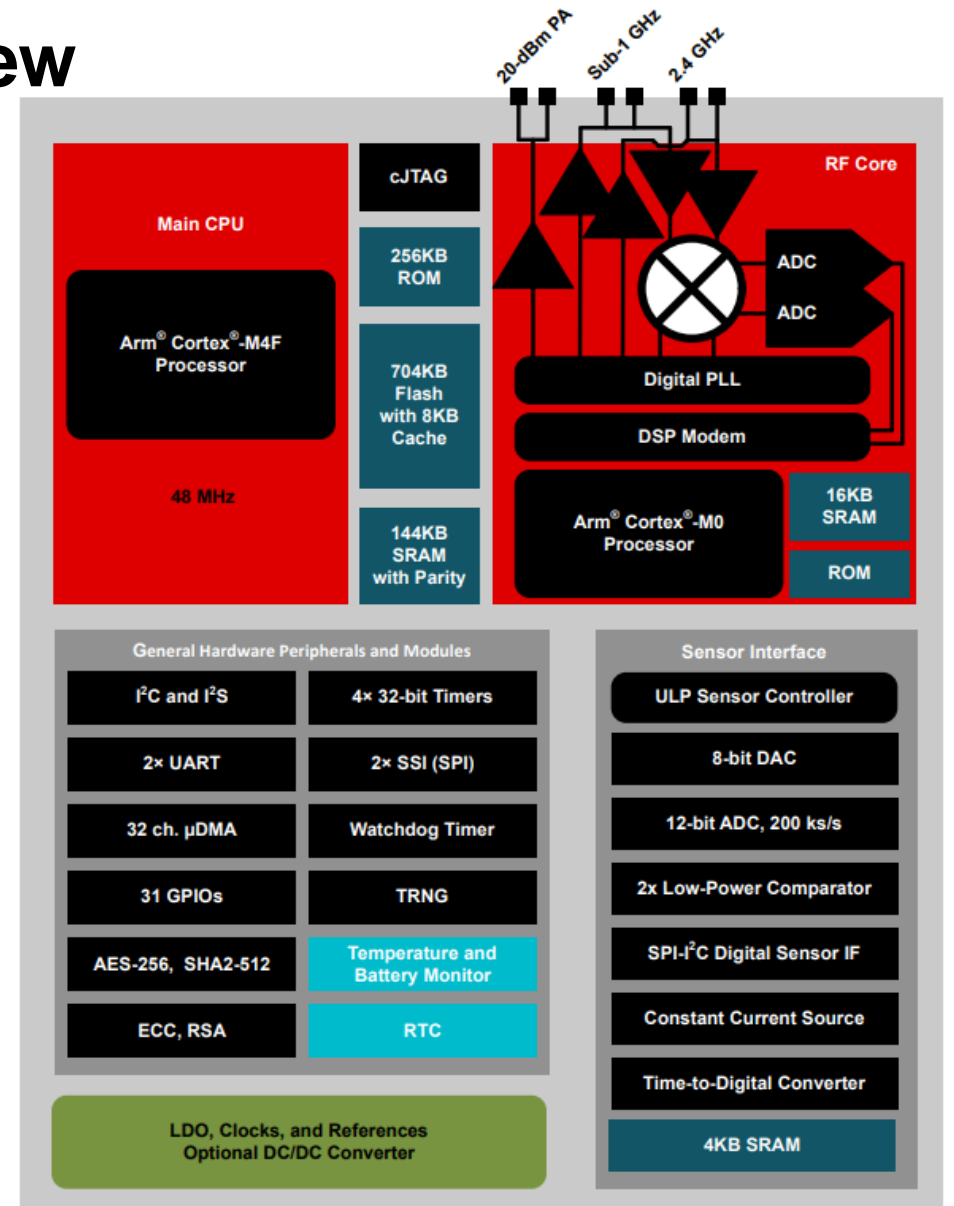
- All Digital Peripheral Pins Can Be Routed to Any GPIO
- Programmable Sensor Controller

Package

- 7x7 mm packaging

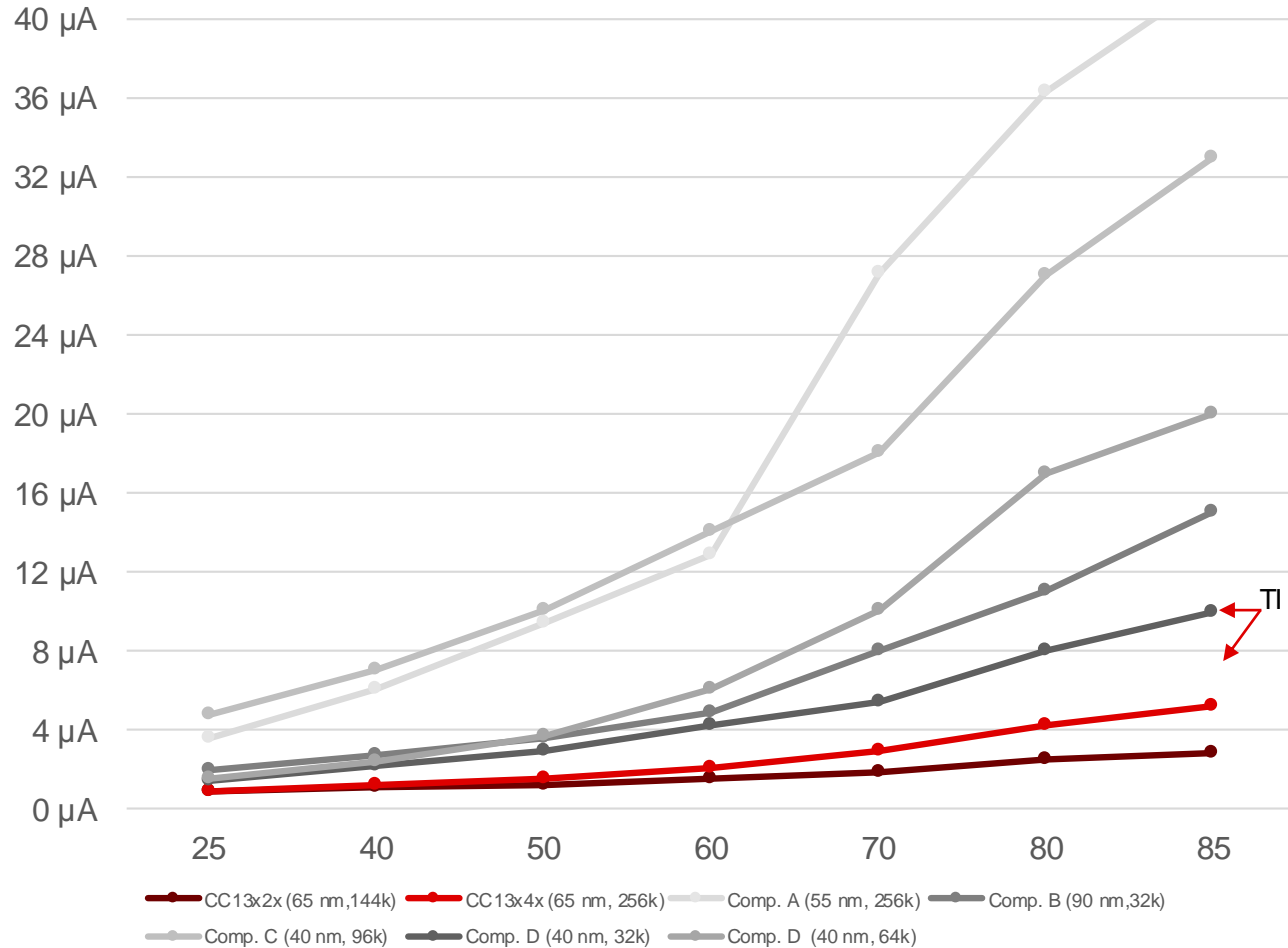
Benefits

- Run larger stacks like Amazon Sidewalk or Wi-SUN
- Enable easy network commissioning with Bluetooth 5.2
- SoC offering long battery lifetime for the complete system (RF and application combined)



Low power consumption

True low power wireless solutions



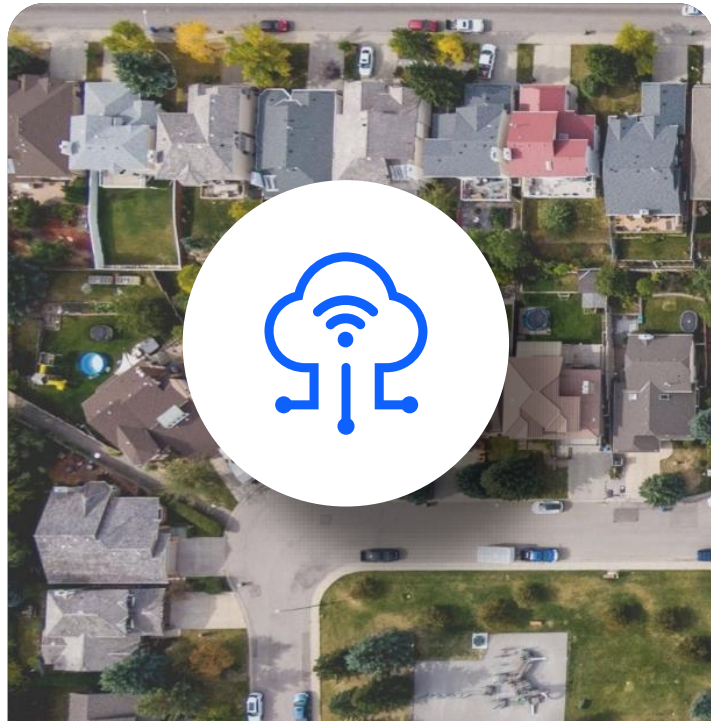
Key Features

- Sub-1 uA standby current even at 256 kB RAM retention
- Low standby current over temperature
- Integrated high power PA 63 mA @ 20 dBm TX
- Sensor Controller

Application Benefits

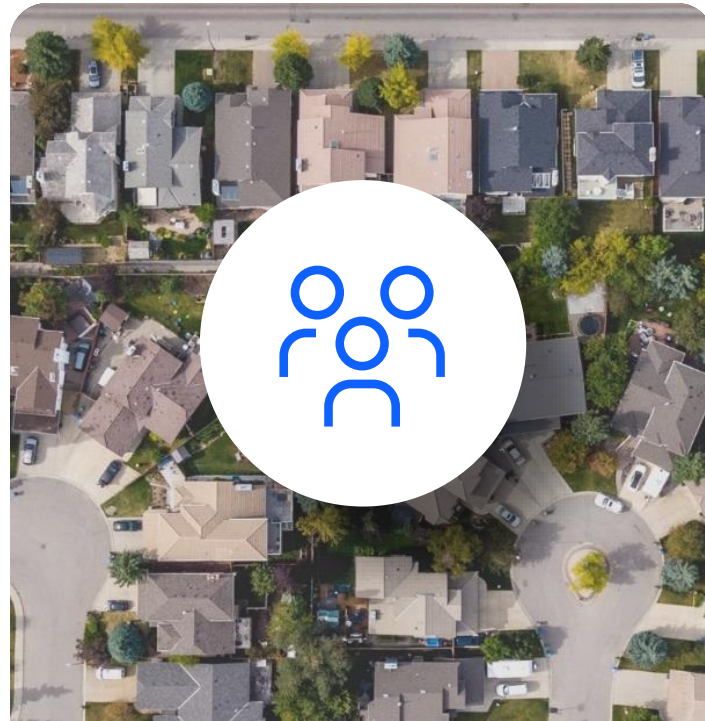
- Longer product lifetime
- Reduce cost with lower peak currents
- Longer battery replacement intervals
- ... even at high temperatures

What is Amazon Sidewalk?



DATA FROM DEVICE TO CLOUD

Sidewalk is a wireless IoT network comprised of millions of Ring and Echo devices



SERVING THE COMMUNITY

It's a public network that is powered by the community and whose devices are meant to better serve the community



DIVERSE USE CASES

Sidewalk combines short and long range wireless technologies to accommodate a variety of use cases

Sidewalk use cases



Inside the home

'Things' that are difficult to connect or remain connected

- Appliances (e.g., laundry)
- Air conditioning filters
- Medical devices (e.g. glucose monitoring)



At the home-edge

'Things' that have issues in staying connected

- Appliances (e.g., HVAC)
- Pool pumps
- Water leak sensors
- Mailbox sensors
- Pathway lights



In the neighborhood

'Things' that move around and need continuous connectivity

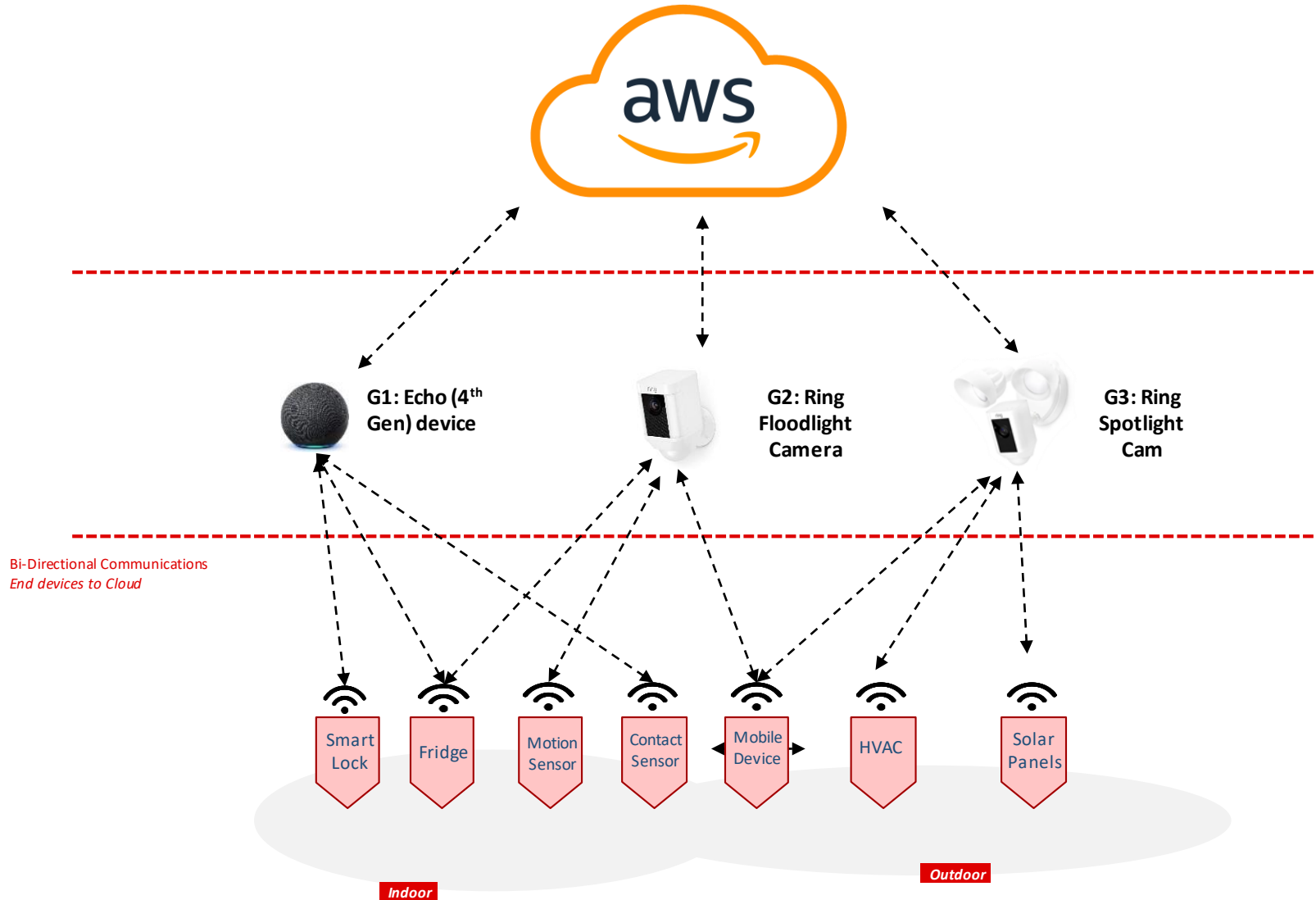
- Last mile delivery trackers
- Car tags
- Cold-chain tracker for food
- Cold chain tracker for pharma

How Amazon Sidewalk Works

Cloud Service

Sidewalk Bridge Devices

3rd party IoT devices



Scale to be supported

Tens of billions of messages

Millions of gateways

Billions of devices

Amazon Sidewalk | TI is your main partner

What is Sidewalk?



- Sidewalk is a ready-to-use stack with security leveraging the 900MHz band
- Extends connectivity beyond Bluetooth and your home Wi-Fi
- Leverages Amazon's existing infrastructure for a crowdsourced network

Benefits



- Eliminates the need to build your own gateway
- Added redundancy with neighboring gateways
- Provides extended range (wall penetration) at a lower cost than cellular
- Immunity to interference (outside of 2.4GHz)

TI Advantage



- Extremely low standby current (0.8uA)
- Highly efficient integrated Power Amplifier (25% lower TX current at +20dBm vs. market)
- Use BLE for easy provisioning & firmware updates with CC1352P7
- Easy to use Sidewalk protocol integrated into TI SDK

Getting Started



- Build a rapid prototype and expand to full development with [LP-CC1352P7 Development kit | TI.com](#)
- Support via local FAEs and TI E2E



False Trigger Mitigation Tool

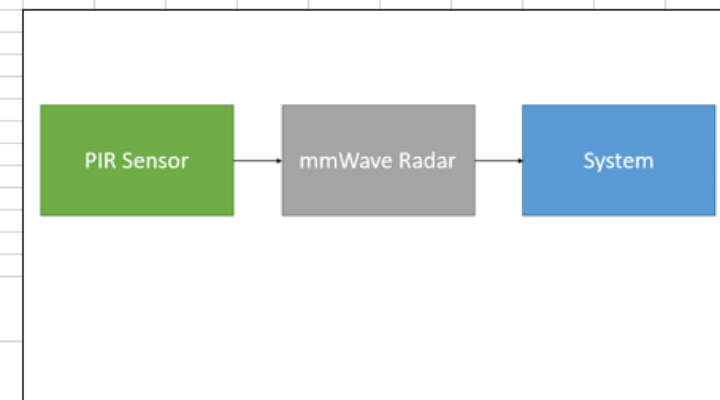
- Uses radar to confirm PIR triggers
- Prevents unnecessary wakeups of camera and system
- Radar can be used for other uses, such as people tracking or gesture control
- High increase in battery life in cases with many false detections

Power Consumption Comparison			
Total Detection Events	% of Events False Triggers	Power Consumption without False Trigger Protection (no radar) (mWh)	Power Consumption with False Trigger Protection (with radar) (mWh)
60	50	1333.296	666.748

Battery Life Comparison			
Detection Events Per Day	% of Events False Triggers	Battery Life without False Trigger Protection (days)	Battery Life with False Trigger Protection (days)
10	50	99.9	199.8

System Configuration				
Default Radar Profile	Select Config:	Presence and Motion	Avg Power (mW):	15
Custom Radar Power	Enter Custom Avg Power:	23		
Radar Time Period	Enter (ms):	400		
System Power	Enter Avg Power (mW):	10000		
System On-Time (Per detection event)	Enter On-Time (ms):	8000		
Radar False Trigger Protection Accuracy (% of false triggers identified correctly):	Enter %:	100	Detected False Triggers (Power Consumption)	30
			Detected False Triggers (Battery Life Comparison):	5
Battery Size	Enter mAh:	6000	Battery mWh:	22200
Battery Voltage (Nominal)	Enter V:	3.7		
Estimated Battery Life (Events, without radar)	999			
Estimated Battery Life (Events, with radar)	999			

Values in blue cells can be modified



Radar Developer Zone

- Example projects including source code, and step-by-step user guides
- Experiments such as radar performance in natural elements, or the testing of other various features
- Direct communication with TI engineers to get support in TI's E2E forums

The screenshot displays the Radar Developer Zone interface. On the left is the 'Resource Explorer' showing a tree view of the 'Radar Toolbox - 1.20.00.11' with categories like 'Applications', 'Documentation', 'Example Projects', and 'Gesture Recognition'. The 'IWRL6432 Gesture Recognition' project is highlighted. On the right is the 'IWRL6432 Gesture Recognition Users Guide' page, which includes a 'Table of Contents' with links to 'Device Compatibility', 'Overview', 'Quickstart', 'Developer's Guide', and 'Need More Help?'. Below the table of contents is a 'Device Compatibility' section with a warning icon and the text 'This lab is currently only compatible with the IWRL6432.' The 'Overview' section contains a paragraph describing the use of TI mmWave sensors for gesture recognition and lists six distinct hand gestures: Left swipe, Right swipe, Up swipe, Down swipe, Push, and Pull at a distance of 2m. Below the text is a video player showing a person performing a gesture, with a 'No Gesture' overlay. The 'Quickstart' and 'Prerequisites' sections are also visible.

CC1312PSIP block diagram

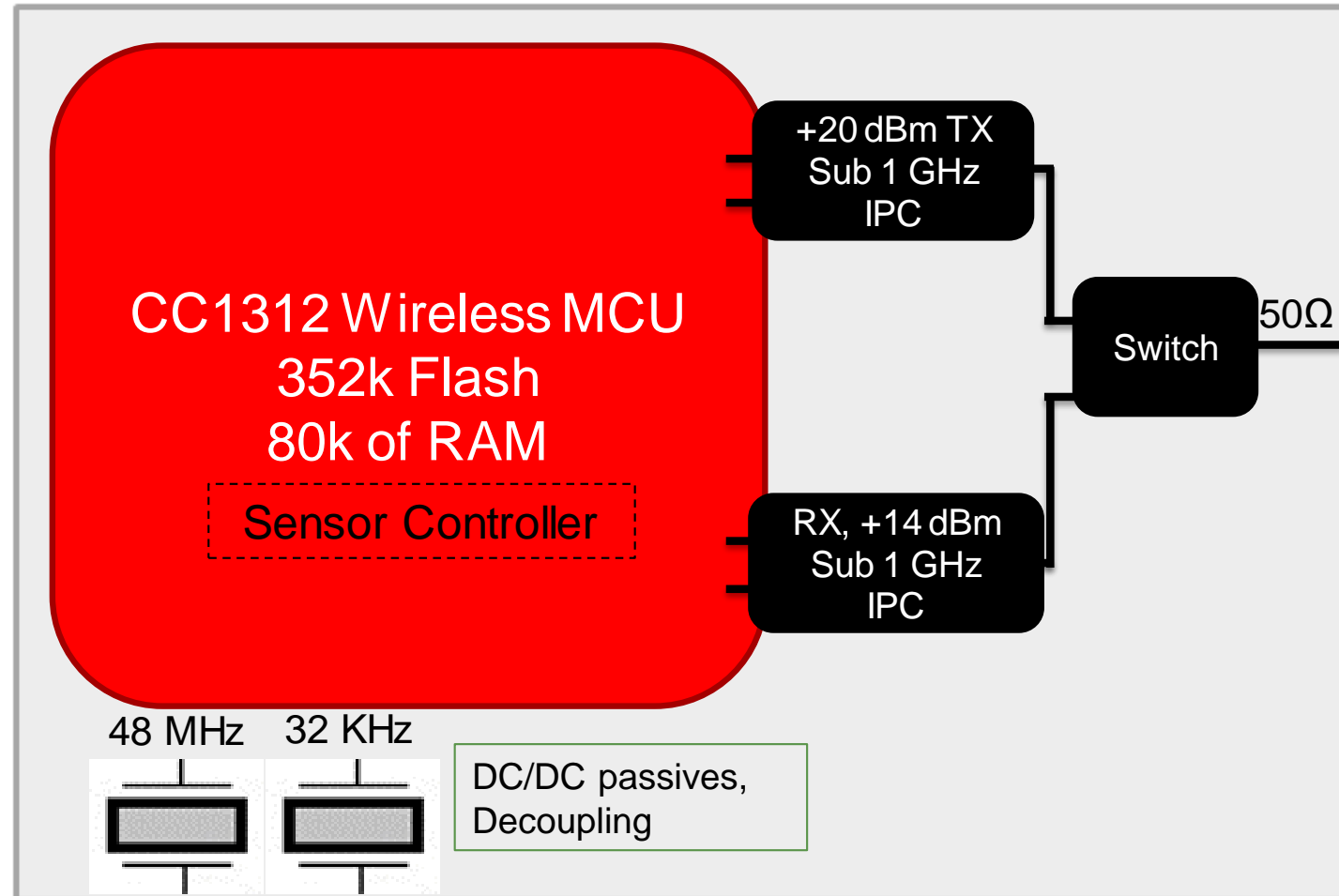
- **Integrated components**

- 32kHz crystal and software temperature compensated RTC (Real Time Clock)
 - ± 50 ppm max for -40 to 65 degrees
- 48 MHz xtal and software temperature compensated RF frequency accuracy:
 - ± 10 ppm from -40 to 65 degrees
 - ± 20 ppm for -40 to 105 degrees
- IPC: Integrated Passive Component for:
 - RX and the +14 dBm TX path (50 Ω)
 - TX: +20 dBm (50 Ω)
- RX/TX switch
- DC/DC inductor and capacitor
- Decoupling capacitors

- The module is shielded

- Ultra Low Power:

- Standby: 0.9 μ A (with RTC and 80k RAM)
- RX: 5.8 mA
- TX: 28.7 mA @ +14 dBm, 70mA @ +19 dBm
- MCU: 2.9 mA (48 MHz running Coremark)



SIPs/Module | How does it save time to market?

Design

ChipDown:

- RF design takes significant time in order to optimize performance (1-6 months)
- Risk of re-spin of the PCB

Module:

- Less PCB area needed (80% area reduction)
- Reduces complexity of layout
- Lower manufacturing and assembly cost considering a single component vs multiple components

Certification

ChipDown:

- Failure to certify can be expensive

Module:

- TI certifies the modules for FCC/IC (saves 2+ months)
- TI certifies the CC1312PSIP Launch Pad for CE (ETSI)

Production Test

ChipDown:

- More advanced production test needed to cover passive components and crystals

Module:

- The CC1312PSIP has been tested by TI, therefore, a much simpler production test can be implemented
- The 48MHz crystal, the RF frequency and the 32kHz crystal have been calibrated



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